

3	an array waveguide having cl	iannels internally, the array waveguide
	itid adiacent to the termin	
4		ling into both the termination block and the
5		mination block comprises two retainers having
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7		wo pins extend into holes formed by placing
8		o retainers together, and wherein the
9	g termination block and the array v	vaveguide are bonded together by an epoxy.
1	3. (Amended) The device of clair	n 1, wherein the array waveguide has two holes
2	2 formed by an etch process.	
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2	2 a gel dispensed between/the	ermination block and the array waveguide.
l	1 5. The device of claim 4, wherein	the gel has an index of refraction substantially
2	2 similar to that of the channels of the arra	y waveguide.
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1	6. (Amended) A method of align	ing a fiber optic bundle with an array waveguide
2	2 comprising:	•
		ned in both the fiber optic bundle and the array
3	waveguide wherein the holes fo	rmed in the fiber optic bundle are formed by
4		
5		le and the array waveguide together so that the
6	· - 1	otic bundle and the array waveguide.
7	pins extend into both the riber of	nic buildle and the array waveguide.
	•	_
1	The method of claim 6 further	comprising: in the fiber optic bundle with channels of the
,	finely aligning ontical fibers	in the fiber optic bundle with channels of the
_	7 Thery arguing optical flocis	in the river of the pariete with entitles of the

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The method of claim 7	
applying an epoxy to	bond the fiber optic bundle to the array waveguide.

- 9. The method of claim 8 further comprising:
  dispensing an optical gel between the fiber optic bundle and the array waveguide.
- 10. The method of claim 9, wherein the optical gel has an index of refraction substantially similar to channels in the array waveguide.
  - 11. The method of claim 10 further comprising:

    curing the epoxy while maintaining alignment between the optical fibers and
    the channels of the array waveguide.
- 12. (Amended) A method of aligning a fiber optic bundle with an array vaveguide comprising:

coarsely aligning the fiber optic bundle with the array waveguide by inserting two pins into holes formed in an end of the fiber optic bundle, wherein the holes formed in the fiber optic bundle are formed by placing two etched substrates together,

inserting opposite ends of the two pins into the array waveguide, and pressing the fiber optic bundle and the array waveguide together; and finely aligning the fiber optic bundle with the array waveguide by adjusting the fiber optic bundle and the array waveguide to improve photonic coupling between optical fibers of the fiber optic bundle and channels of the array waveguide.

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14. (Amended) The method of claim 12 further comprising:
dispensing an epoxy between the fiber optic bundle and the array waveguide.

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15. The method of claim 14, wherein the dispensing the epoxy is performed by dispensing an epoxy having an index of refraction substantially similar to the channels of the array waveguide.

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16. (New) The method of claim 6, wherein the two etched substrates are placed
2 hogether to form multiple holes, and the multiple holes are filled by optical fibers except
3 for the holes with the pins inserted in them.

17. (New) The method of claim 12, wherein the two etched substrates are placed together to form multiple holes, and the multiple holes are filled by optical fibers except for the holes with the pins inserted in them.

Serial No.: 09/738,686